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AO7414 N-Channel Enhancement Mode Field Effect Transistor

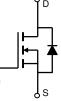
General Description

The AO7414 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V, in the small SOT-323 footprint. It can be used for a wide variety of applications, including load switching, low current inverters and low current DC-DC converters. AO7414 and AO7414L are electrically identical. -RoHS Compliant -AO7414L is Halogen Free

Features

$$\begin{split} & \mathsf{V}_{\text{DS}} \; (\mathsf{V}) = 20\mathsf{V} \\ & \mathsf{I}_{\text{D}} = 2 \; \mathsf{A} \; \; (\mathsf{V}_{\text{GS}} = 4.5\mathsf{V}) \\ & \mathsf{R}_{\text{DS}(\text{ON})} < 62 \mathrm{m}\Omega \; (\mathsf{V}_{\text{GS}} = 4.5\mathsf{V}) \\ & \mathsf{R}_{\text{DS}(\text{ON})} < 70 \mathrm{m}\Omega \; (\mathsf{V}_{\text{GS}} = 2.5\mathsf{V}) \\ & \mathsf{R}_{\text{DS}(\text{ON})} < 85 \mathrm{m}\Omega \; (\mathsf{V}_{\text{GS}} = 1.8\mathsf{V}) \end{split}$$





Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	20	V	
Gate-Source Voltage		V _{GS}	±8	V	
Continuous Drain	T _A =25°C		2		
Current ^A	T _A =70°C	I _D	1.5	А	
Pulsed Drain Current ^B		I _{DM}	25	7	
	T _A =25°C	- P _D	0.35	w	
Power Dissipation ^A	T _A =70°C	r D	0.22	vv	
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C	

Thermal Characteristics									
Parameter	Symbol	Тур	Max	Units					
Maximum Junction-to-Ambient A	t ≤ 10s	$-R_{\theta JA}$	300	360	°C/W				
Maximum Junction-to-Ambient ^A	Steady-State	Γ _θ JA	340	425	°C/W				
Maximum Junction-to-Lead ^C	Steady-State	$R_{ ext{ heta}JL}$	280	320	°C/W				

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC	PARAMETERS					-	
BV_{DSS}	Drain-Source Breakdown Voltage	$I_{D}=250\mu A, V_{GS}=0V$		20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =20V, V _{GS} =0V				1	μA
			T _J =55°C			5	
I _{GSS}	Gate-Body leakage current	$V_{DS}=0V, V_{GS}=\pm 8V$				±100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$		0.5	0.68	1	V
I _{D(ON)}	On state drain current	V_{GS} =4.5V, V_{DS} =5V		25			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V_{GS} =4.5V, I _D =2A			50	62	mΩ
			T _J =125°C		70	90	
		V _{GS} =2.5V, I _D =1.8A			56	70	mΩ
		$V_{GS}=1.8V, I_{D}=1A$			66	85	
g _{FS}	Forward Transconductance	$V_{DS}=5V, I_{D}=2A$			15		S
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.7	1	V	
ls	Maximum Body-Diode Continuous Cu	urrent				0.35	Α
DYNAMI	C PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =10V, f=1MHz			260	320	pF
C _{oss}	Output Capacitance				48		pF
C _{rss}	Reverse Transfer Capacitance				27		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			3	4.5	Ω
SWITCH	ING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =10V, I _D =2A			2.9	3.8	nC
Q _{gs}	Gate Source Charge				0.4		nC
Q_{gd}	Gate Drain Charge				0.6		nC
t _{D(on)}	Turn-On DelayTime	V_{GS} =4.5V, V_{DS} =10V, R_{L} =5 Ω , R_{GEN} =6 Ω			2.5		ns
t _r	Turn-On Rise Time				3.2		ns
t _{D(off)}	Turn-Off DelayTime				21		ns
t _f	Turn-Off Fall Time		F		3		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =2A, dI/dt=100A/µs			14	19	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =2A, dI/dt=100A/μs			3.4		nC

A: The value of R_{6JA} is measured with the device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\rm 6JA}$ is the sum of the thermal impedence from junction to lead R $_{\rm 6JL}$ and lead to ambient.

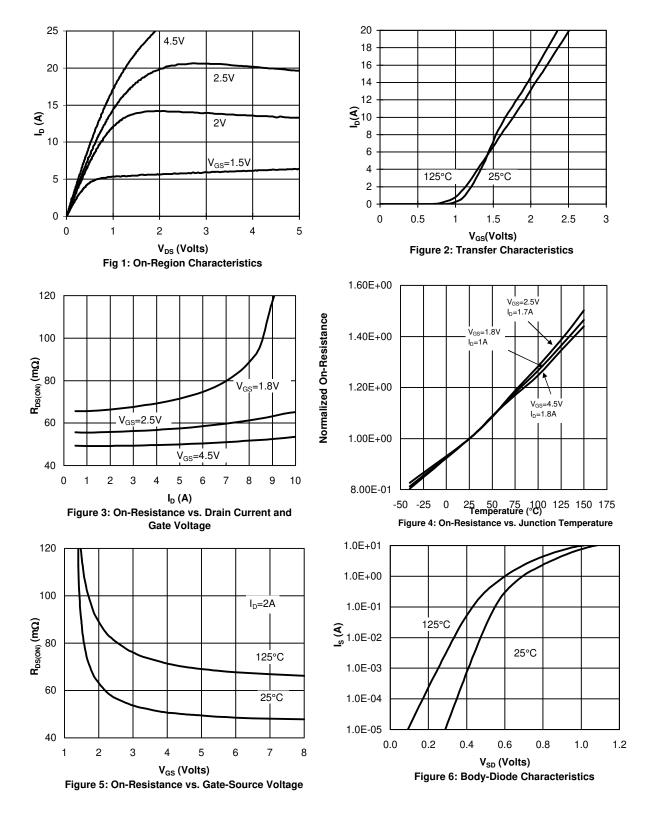
D. The static characteristics in Figures 1 to 6 are obtained using $<300\mu$ s pulses, duty cycle 0.5% max.

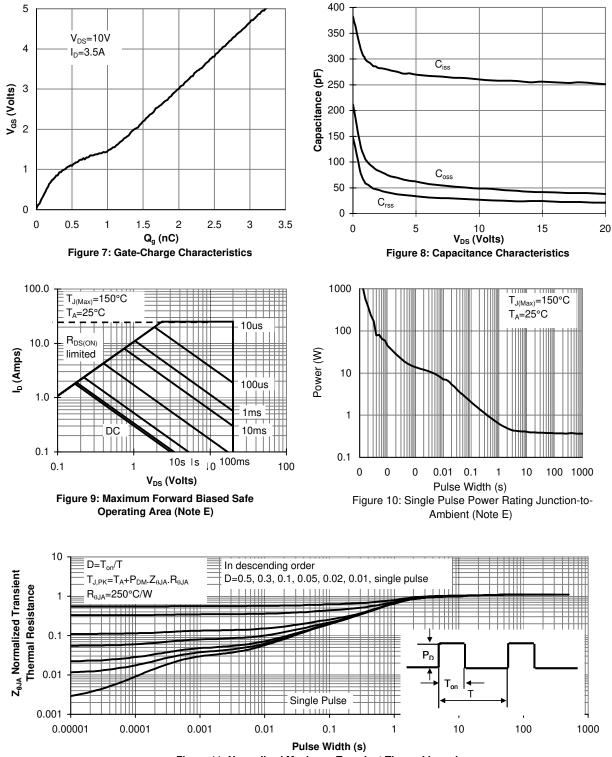
E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25$ °C. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





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Figure 11: Normalized Maximum Transient Thermal Impedance